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Dent Namel			
Part Number:	<u>43045-1009</u>		\sim
Status:	Active		
Overview:	Micro-Fit 3.0 [™] Connectors		
Description:		face Mount, Dual Row, Right Angle, with Solder Tab, 10	
	Circuits, Tin (Sn) Plating, Gl		
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Documents:			
3D Model		Test Summary TS-43045-001 (PDF)	
Drawing (PDF)		RoHS Certificate of Compliance (PDF)	
Product Specification	D PS-43045 (PDF)	Product Literature (PDF)	Series
- reader op semication			image - Reference only
Agency Certifica	ation		
CSA		LR19980	EU RoHS China RoHS
TUV		R72081037	ELV and RoHS
UL		E29179	Compliant
0L		223113	REACH SVHC
General			Contains SVHC: No
Product Family		PCB Headers	Low-Halogen Status
Series		43045	Low-Halogen
Application		Power, Wire-to-Board	
Comments		"High Temperature Square Pin Solder Type <p><p>This</p></p>	Need more information on product
		Molex product is manufactured from material that has	environmental compliance?
		the following ratings, tested by independent agencies:.	Email productcompliance@molex.com
		a) A Glow Wire Ignition Temperature (GWIT) of at	For a multiple part number RoHS Certificate of
		least 775 deg C per IEC 60695-2-13 b) A Glow	Compliance, click here
		Wire Flammability Index (GWFI) above 850 deg C	
		per IEC 60695-2-12.and hence complies with the	Please visit the Contact Us section for any
		requirements set out in the International Standard IEC	non-product compliance questions.
		60335-1 5th edition - household and similar electrical	
		appliances - safety, section 30 Resistance to heat	
		and fire. <p><p> The customers using this product</p></p>	
		must determine its suitability for use in their particular	Search Parts in this Series
		application through testing or other acceptable means	43045Series
		as described in end-product glow-wire flammability test	
		standard IEC 60695-2-11 and any applicable product	Mates With
		end-use standard(s). <p> If it is determined during</p>	43025 Micro-Fit 3.0 [™] Receptacle Housing
		the customer's evaluation of suitability, that higher	
		performance is required, please contact Molex for	
		possible product options."	
Overview		Micro-Fit 3.0 [™] Connectors	
Product Literature O	rder No	987650-5984	
Product Name		Micro-Fit 3.0™	
UPC		800754372374	
Physical			
Breakaway		No	
Circuits (Loaded)		10	
Circuits (maximum)		10	
Color - Resin		Black	
Durability (mating cy	cles max)	30	
Flammability		94V-0	
Glow-Wire Complian	t	Yes	
Mated Height		10.29mm	
Material - Metal		Brass	
material metal		2.000	

Material - Metal Material - Plating Mating Material - Plating Termination

Brass Tin

Tin

Material - Resin	High Temperature Thermoplastic
Net Weight	1.628/g
Number of Rows	2
Orientation	Right Angle
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Packaging Type	Embossed Tape on Reel
Pitch - Mating Interface	3.00mm
Plating min - Mating	0.254µm
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	N/A -40°C to +105°C
Temperature Range - Operating Termination Interface: Style	Surface Mount
remination intenace. Style	Sunace mount
Electrical	
Electrical Current - Maximum per Contact	54
Current - Maximum per Contact	5A 600V
	5A 600V
Current - Maximum per Contact	•
Current - Maximum per Contact Voltage - Maximum	•
Current - Maximum per Contact Voltage - Maximum Solder Process Data	600V
Current - Maximum per Contact Voltage - Maximum Solder Process Data Duration at Max. Process Temperature (seconds)	600V 30
Current - Maximum per Contact Voltage - Maximum Solder Process Data Duration at Max. Process Temperature (seconds) Lead-free Process Capability	600V 30 Reflow Capable (SMT only)
Current - Maximum per Contact Voltage - Maximum Solder Process Data Duration at Max. Process Temperature (seconds) Lead-free Process Capability Max. Cycles at Max. Process Temperature Process Temperature max. C	600V 30 Reflow Capable (SMT only) 3
Current - Maximum per Contact Voltage - Maximum Solder Process Data Duration at Max. Process Temperature (seconds) Lead-free Process Capability Max. Cycles at Max. Process Temperature	600V 30 Reflow Capable (SMT only) 3
Current - Maximum per Contact Voltage - Maximum Solder Process Data Duration at Max. Process Temperature (seconds) Lead-free Process Capability Max. Cycles at Max. Process Temperature Process Temperature max. C Material Info	600V 30 Reflow Capable (SMT only) 3
Current - Maximum per Contact Voltage - Maximum Solder Process Data Duration at Max. Process Temperature (seconds) Lead-free Process Capability Max. Cycles at Max. Process Temperature Process Temperature max. C Material Info Reference - Drawing Numbers	600V 30 Reflow Capable (SMT only) 3 260
Current - Maximum per Contact Voltage - Maximum Solder Process Data Duration at Max. Process Temperature (seconds) Lead-free Process Capability Max. Cycles at Max. Process Temperature Process Temperature max. C Material Info	600V 30 Reflow Capable (SMT only) 3 260 PS-43045, RPS-43025-004, RPS-43045-003,
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